

November 2013

# FQPF6N80T

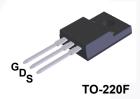
# N-Channel QFET $^{\circledR}$ MOSFET 800 V, 3.3 A, 1.95 $\Omega$

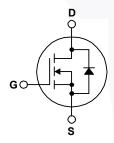
# **Description**

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

### **Features**

- 3.3 A, 800 V,  $R_{DS(on)}$  = 1.95  $\Omega$  (Max.) @  $V_{GS}$  = 10 V,  $I_D$  = 1.65 A
- Low Gate Charge (Typ. 31 nC)
- Low Crss (Typ. 14 pF)
- · 100% Avalanche Tested
- · 100% Package Isolation Tested





# Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter		FQPF6N80T	Unit
$V_{DSS}$	Drain-Source Voltage		800	V
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°	C)	3.3	Α
	- Continuous (T <sub>C</sub> = 100	)°C)	2.1	Α
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	13.2	Α
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	680	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	3.3	Α
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	5.1	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.0	V/ns
$P_{D}$	Power Dissipation (T <sub>C</sub> = 25°C)		51	W
	- Derate above 25°C		0.41	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
T <sub>L</sub>	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

# **Thermal Characteristics**

Symbol	Parameter	FQPF6N80T	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	2.45	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	

# **Package Marking and Ordering Information**

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQPF6N80T	FQPF6N80T	TO-220F	Tube	N/A	N/A	50 units

# **Electrical Characteristics**

T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Mi	1 Тур	Max	Unit
Off Cha	aracteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	80	)		V
$\Delta BV_{DSS}$ / $\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$ , Referenced to 2	5°C	0.9		V/°C
I <sub>DSS</sub>	Zero Cata Valta de Dueiro Compant	V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V			10	μА
	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 640 V, T <sub>C</sub> = 125°C			100	μΑ
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Cha	aracteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0	)	5.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10 V, I <sub>D</sub> =1.65 A	\	1.5	1.95	Ω
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 1.65 A		4.3		S
C <sub>iss</sub>	Input Capacitance Output Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz		1150 125	1500 160	pF pF
C <sub>rss</sub>	Reverse Transfer Capacitance			14	18	pF
Switchi	ing Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, I_{D} = 5.8 \text{ A},$ $R_{G} = 25 \Omega$		30	70	ns
t <sub>r</sub>	Turn-On Rise Time			70	150	ns
t <sub>d(off)</sub>	Turn-Off Delay Time			65	140	ns
t <sub>f</sub>	Turn-Off Fall Time	(No	ote 4)	45	100	ns
Qg	Total Gate Charge	$V_{DS}$ = 640 V, $I_{D}$ = 5.8 A, $V_{GS}$ = 10 V (Note 4)		31		nC
Q <sub>gs</sub>	Gate-Source Charge			7.1		nC
Q <sub>gd</sub>	Gate-Drain Charge			15	/	nC
	Name of Diade Observatorial (	. d Marrian Dati			y.	
שrain-S	Source Diode Characteristics an				3.3	Α
lc	Maximum Continuous Drain-Source Dic	Maximum Continuous Drain-Source Diode Forward Current  Maximum Pulsed Drain-Source Diode Forward Current			0.0	, , ,
					13.2	Δ
I <sub>S</sub> I <sub>SM</sub> V <sub>SD</sub>	Maximum Continuous Drain-Source Diode F  Maximum Pulsed Drain-Source Diode F  Drain-Source Diode Forward Voltage			/	13.2	A V

# $Q_{rr}$

- Notes: Notes: Notes: A Repetitive Rating: Pulse width limited by maximum junction temperature. 
  2. L = 117 mH, I<sub>AS</sub> = 3.3 A, V<sub>DD</sub> = 50 V, R<sub>G</sub> = 25  $\Omega$ , starting T<sub>J</sub> = 25°C. 
  3. I<sub>SD</sub>  $\leq$  5.8 A, di/dt  $\leq$  200 A/µs, V<sub>DD</sub>  $\leq$  BV<sub>DSS</sub>, starting T<sub>J</sub> = 25°C. 
  4. Essentially independent of operating temperature. 
  5. Viso=4000V, t=0.3s in single pulse, UL recognized.

Reverse Recovery Charge

μС

5.7

 $dI_F / dt = 100 A/\mu s$ 

# **Typical Characteristics**

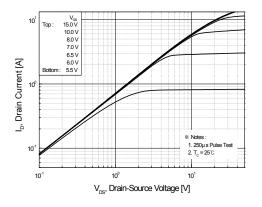


Figure 1. On-Region Characteristics

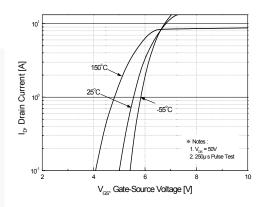


Figure 2. Transfer Characteristics

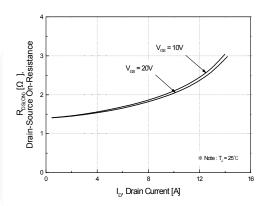


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

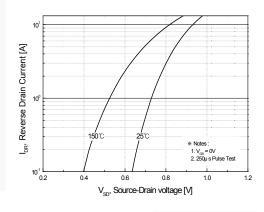


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

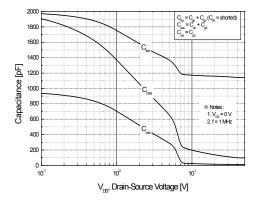


Figure 5. Capacitance Characteristics

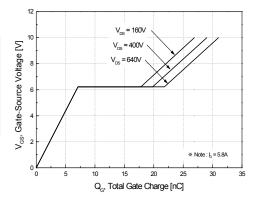
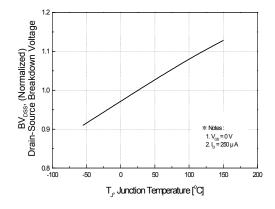


Figure 6. Gate Charge Characteristics

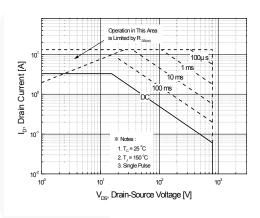
# Typical Characteristics (continued)



3.0 (paging 2.5 (paging 2.0 (p

Figure 7. Breakdown Voltage Variation vs Temperature

Figure 8. On-Resistance Variation vs Temperature



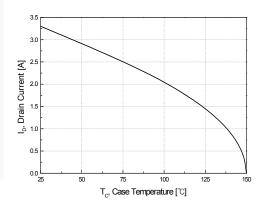


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs Case Temperature

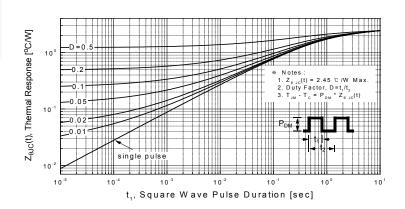


Figure 11. Transient Thermal Response Curve

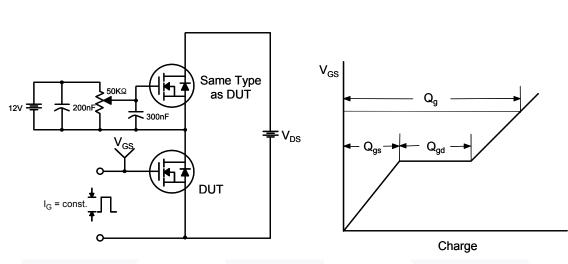


Figure 12. Gate Charge Test Circuit & Waveform

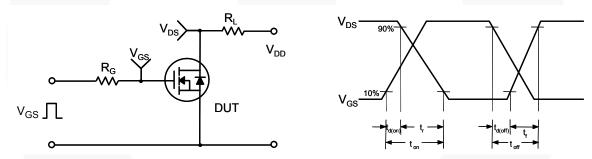


Figure 13. Resistive Switching Test Circuit & Waveforms

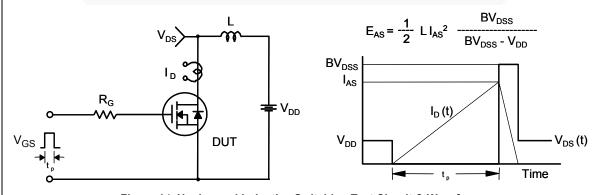
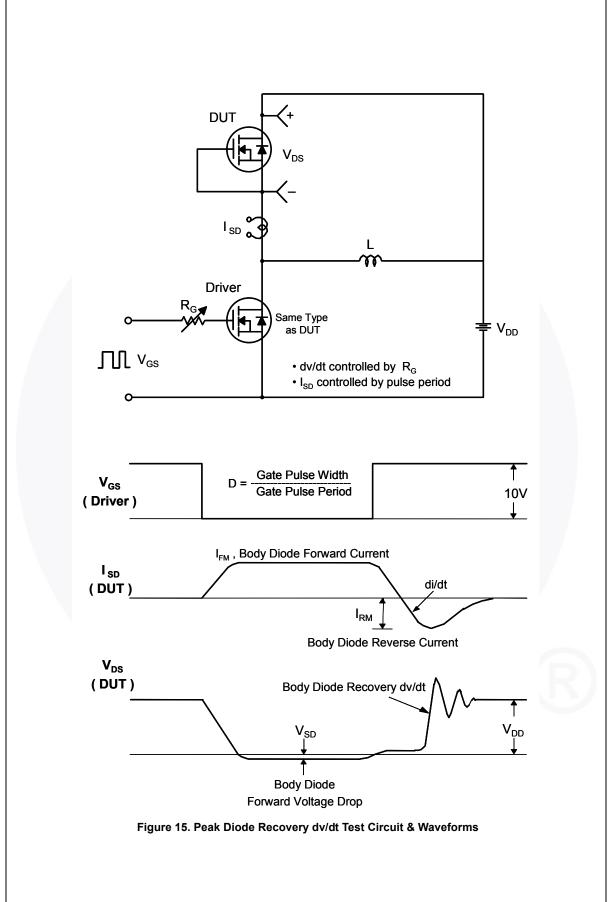


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



# **Mechanical Dimensions**

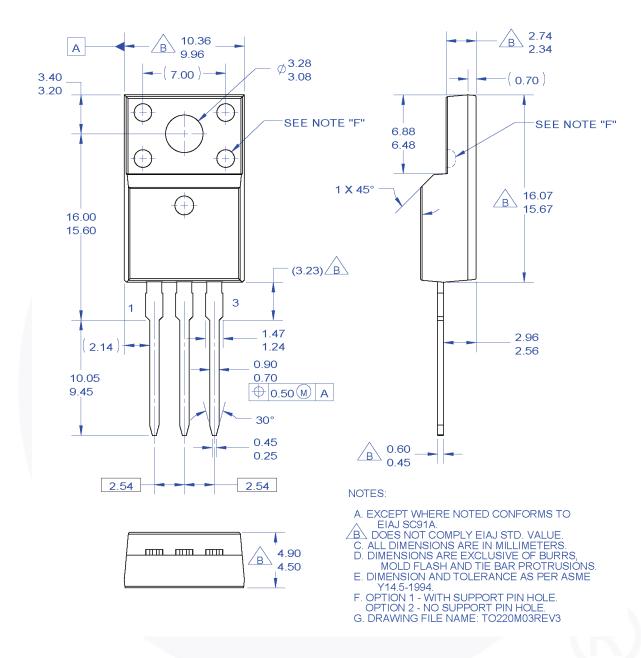


Figure 16. TO220, Molded, 3-Lead, Full Pack, EIAJ SC91, Straight Lead

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